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16-CHANNEL (4 BANKS OF 4-CHANNEL) HIGH-VOLTAGE ANALOG SWITCH

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The ABLIC Inc. HDL6M06502B is 16-channel high-voltage analog switch IC operated only by a single 5V for ultrasound imaging applications.

The HDL6M06502B consists of 4 sets of 4 single-pole, single-throw (SPST) analog switches controlled by 4 logic inputs. The HDL6M06502B has a unique pin-out which makes PCB traces easier.

Functions

• 16-channel (4 banks of 4-channel) high-voltage SPST analog switch with active ground clamp

Features

- 0V to ±100V analog signal voltage range (10kHz to 20MHz signal frequency range)
- 2A peak analog signal current per channel
- 8Ω main switch on-resistance
- 40kΩ bleed resistor on probe side
- Low on/off-capacitance
- -52dB off-isolation at 5MHz (load-independent)
- -60dB switch crosstalk
- 20Ω ground clamp switch on probe side alternately turned on/off with main switch
- DS_ASW to disable 20Ω ground clamp switch
- 1.8V to 5V CMOS logic interface
- Single +5V power supply (NO HIGH-VOLTAGE POWER SUPPLY required)
- Low power dissipation (static 1mW)
- Unique pin configuration for easy PCB traces (SPs on one side and STs on opposite side)
- 52-lead 8x8mm QFN package (RoHS compliant)

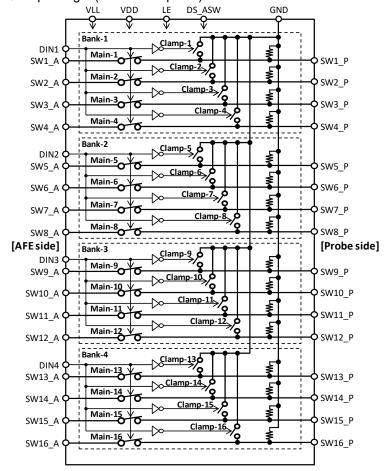


Fig.1 Block diagram ABLIC Inc.

1. Absolute Maximum Ratings

T_A=25°C unless otherwise noted.

Table 1 Absolute Maximum Ratings

No.	Items	Symbol	Value	Units	Condition
1	Positive logic supply voltage	V _{LL}	-0.4 to +7	V	
2	Positive supply voltage	V_{DD}	-0.4 to +7	V	
3	Logic input voltage (x=1~4)	DINx, LE, DS_ASW	-0.4 to +7	V	
4	Analog signal range	VsiG	-105 to +105	V	
			-105 to +105	V	SW_A
	Peak analog signal current per channel		-105 to +105	V	SW_P when Switch ON
5		Isw	-2 to +2	٧	SW_P when Switch OFF, DS_ASW=0
			-105 to +105	V	SW_P when Switch OFF, DS_ASW=1
6	Operating junction temperature	T _{Jop}	-20 to +150	°C	
7	Storage temperature	TstG	-55 to +150	°C	
8	Maximum power dissipation	P _{Dmax}	4	W	

NOTE: * Stresses beyond the absolute maximum ratings may cause permanent damage to the product.

2. Operating Supply Voltages, Logic Inputs, and Application Circuits

2.1 Operating Supply Voltages, Temperature, and Logic Inputs

Table 2 Operating Supply Voltages and Logic Inputs

No	Items	Symbol	Min	Тур	Max	Units	Condition
1	Logic supply voltage	V _{LL}	1.7	1.8 to 5	V_{DD}	V	
2	Positive supply voltage	V_{DD}	4.75	5	5.25	V	
3	IC substrate voltage *1	VsuB	-	0	-	V	
4	Operating free-air temperature	T _A	0		75	°C	
5	High-level logic input voltage	V _{IH}	0.8V _{LL}	-	V_{LL}	V	
6	Low-level logic input voltage	VIL	0	-	0.2V _{LL}	V	
7	Logic input high current *2	Іін	-10	-	10	μA	
8	Logic input low current	lıL	-10	-	10	μA	DINx (x=1~4), LE, DS ASW
9	Logic input capacitance	Cin	-	2	1	pF	26_7.6
10	Setup time	t _{SU}	20	-	-	ns	
11	Hold time	thld	20	-	ı	ns	
12	LE time width	t _{LEW}	20	-	-	ns	

NOTE:

2.2 Power Supply Sequencing

No power supply sequencing is required even if V_{LL} is different from V_{DD} . Please apply the V_{DD} voltage to the V_{LL} when operating with a single 5V.

^{*1)} Thermal pad on the bottom of the package must be soldered to the ground.

^{*2)} DS_ASW has 100 μ A leakage at VLL=5V due to 50k Ω internal pull-down resistor.

2.3 Application Circuits

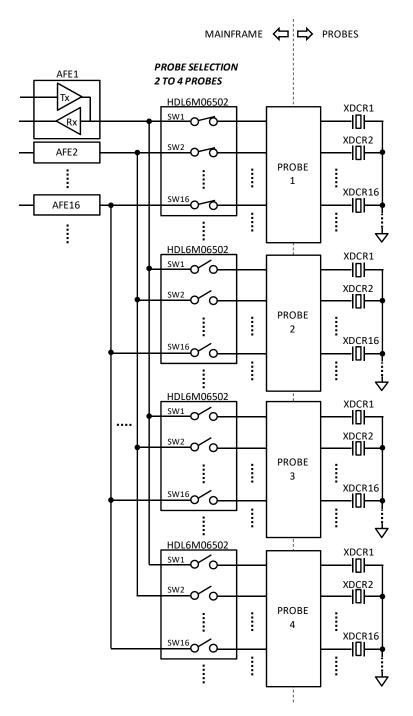


Fig.2 Probe selection (2 to 4 probes) in ultrasound imaging application

3. Electrical Characteristics

DC Characteristics

Table 3 DC Characteristics

V_{LL}=3.3V, V_{DD}=5V, LE=0, DS_ASW=0, T_A=25°C, unless otherwise specified.

	.,	0 1 1		Spec		11.3	0 1:4:
No.	Items	Symbol	Min	Тур	Max	Units	Conditions
1	Analog signal range	VsiG	-100	-	+100	V	
2	V _{LL} quiescent current	ILLQ	-	0.1	-	μΑ	Quiescent current-1
3	V _{DD} quiescent current	Iddq	1	250	-	μΑ	All main switches off
4	V _{LL} quiescent current	ILLQ	1	0.1	-	μA	Quiescent current-2
5	V _{DD} quiescent current	I _{DDQ}	1	250	-	μA	All main switches on
6	V _{LL} dynamic current	ILL	-	0.4	1	μΑ	Dynamic current
7	V _{DD} dynamic current	I _{DD}	-	1.6	2	mA	All channels switching simultaneously at f _{Sw} =50kHz
8	DC offset main switch off	Vos	1	0	-	mV	
9	Small signal main switch on-resistance	Rons	-	8	10	Ω	V_{SIG} =0.1 V pp to 5 V pp @5 M Hz, R_{S} =10 Ω
10	Small signal main switch on-resistance matching	ΔRons	-	2	5	%	V _{SIG} =0V, I _{SIG} =5mA
11	Large signal main switch on-resistance	Ronl	-	8	-	Ω	Vsig=20Vpp@5MHz, Rs=10Ω
12	GND clamp on-resistance	Roncl	-	20	-	Ω	Main switches off, probe side
13	Shunt resistance	R _{BLD}	30	40	50	kΩ	Probe side
14	Switch output peak current	Isw	-	2	-	Α	100ns pulse, 0.1% duty cycle

AC Characteristics

Table 4 AC Characteristics

V_{LL}=3.3V, V_{DD}=5V, LE=0, DS_ASW=0, T_A=25°C, unless otherwise specified.

No	Itoma	Cumbal	Spec			11-:4-	Canditiana	
No.	Items	Symbol	Min	Тур	Max	Units	Conditions	
	T	ton	-	2	5	μs		
1	Turn-on time	ton_asw	-	2	5	μs		
	Turn off times	toff	-	2	5	μs		
2	Turn-off time	toff_asw	-	2	5	μs		
3	Output switching frequency	fsw	-	-	50	kHz	Duty cycle=50%	
4	Small signal frequency	fsig	0.01	-	20	MHz	C _L =220pF	
5	Off in alation	\/	-	-49	-	dB	$f_{SIG}=5MHz$, $R_L//C_L=1k\Omega//15pF$	
٥	Off isolation	Viso	-	-52	-	dB	fsig=5MHz, RL=50Ω	
6	Crosstalk	Vст	-	-60	-	dB	f_{SIG} =5MHz, R_L =50 Ω	
7	Off capacitance to GND	Coff	-	30	-	pF	V _{SIG} =0V, f _{SIG} =1MHz	
8	On capacitance to GND	Con	-	15	_	pF	V _{SIG} =0V, f _{SIG} =1MHz	
9	Output spike voltage	Vspk	-10	90	150	mV	50Ω load	

4. Logic Timing

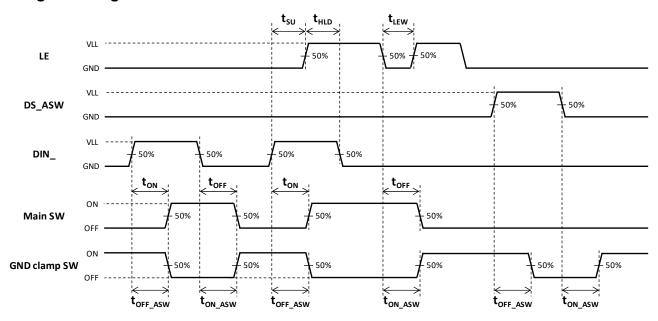


Fig.3 Logic Timing

5. Test Circuits

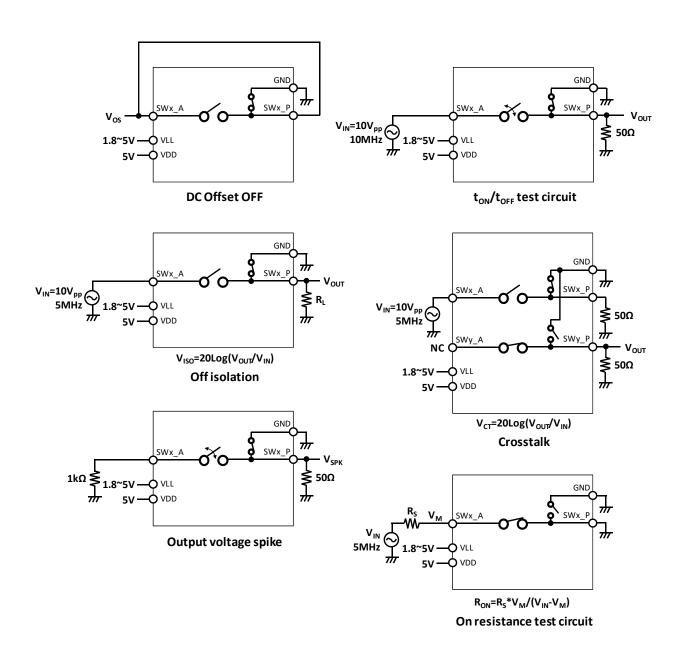


Fig.4 Test Circuits

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6. Truth Table

Table 5 Truth table

Logic Inputs					Analog Switch State								
LE	DS ASW	DIN4	DIN3	DIN2	DIN1	SW131	o SW16	SW9 to	SW12	SW5 t	o SW8	SW1 1	o SW4
LE	DS_ASW	DIN4	פאוט	DINZ	DINT	Main SW	Clamp SW	Main SW	Clamp SW	Main SW	Clamp SW	Main SW	Clamp SW
0	0	0	0	0	0	OFF	ON	OFF	ON	OFF	ON	OFF	ON
0	0	0	0	0	1	OFF	ON	OFF	ON	OFF	ON	ON	OFF
0	0	0	0	1	0	OFF	ON	OFF	ON	ON	OFF	OFF	ON
0	0	0	0	1	1	OFF	ON	OFF	ON	ON	OFF	ON	OFF
0	0	0	1	0	0	OFF	ON	ON	OFF	OFF	ON	OFF	ON
0	0	0	1	0	1	OFF	ON	ON	OFF	OFF	ON	ON	OFF
0	0	0	1	1	0	OFF	ON	ON	OFF	ON	OFF	OFF	ON
0	0	0	1	1	1	OFF	ON	ON	OFF	ON	OFF	ON	OFF
0	0	1	0	0	0	ON	OFF	OFF	ON	OFF	ON	OFF	ON
0	0	1	0	0	1	ON	OFF	OFF	ON	OFF	ON	ON	OFF
0	0	1	0	1	0	ON	OFF	OFF	ON	ON	OFF	OFF	ON
0	0	1	0	1	1	ON	OFF	OFF	ON	ON	OFF	ON	OFF
0	0	1	1	0	0	ON	OFF	ON	OFF	OFF	ON	OFF	ON
0	0	1	1	0	1	ON	OFF	ON	OFF	OFF	ON	ON	OFF
0	0	1	1	1	0	ON	OFF	ON	OFF	ON	OFF	OFF	ON
0	0	1	1	1	1	ON	OFF	ON	OFF	ON	OFF	ON	OFF
0	1	0	0	0	0	OFF	OFF	OFF	OFF	OFF	OFF	OFF	OFF
0	1	0	0	0	1	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
0	1	0	0	1	0	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF
0	1	0	0	1	1	OFF	OFF	OFF	OFF	ON	OFF	ON	OFF
0	1	0	1	0	0	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF
0	1	0	1	0	1	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF
0	1	0	1	1	0	OFF	OFF	ON	OFF	ON	OFF	OFF	OFF
0	1	0	1	1	1	OFF	OFF	ON	OFF	ON	OFF	ON	OFF
0	1	1	0	0	0	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF
0	1	1	0	0	1	ON	OFF	OFF	OFF	OFF	OFF	ON	OFF
0	1	1	0	1	0	ON	OFF	OFF	OFF	ON	OFF	OFF	OFF
0	1	1	0	1	1	ON	OFF	OFF	OFF	ON	OFF	ON	OFF
0	1	1	1	0	0	ON	OFF	ON	OFF	OFF	OFF	OFF	OFF
0	1	1	1	0	1	ON	OFF	ON	OFF	OFF	OFF	ON	OFF
0	1	1	1	1	0	ON	OFF	ON	OFF	ON	OFF	OFF	OFF
0	1	1	1	1	1	ON	OFF	ON	OFF	ON	OFF	ON	OFF
1	Х	Х	Х	Х	Х				Hold Prev	ious State			

7. Pin Configuration

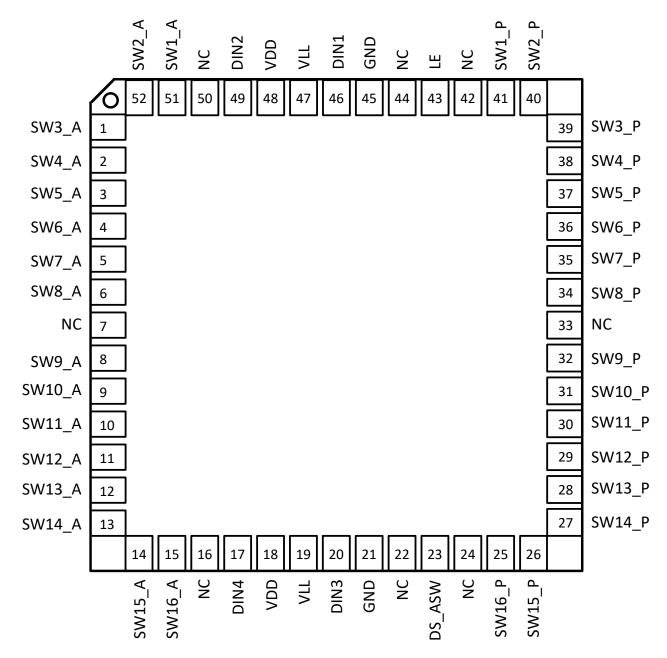


Fig.5 Pin Configuration

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Table 6 Pin Configuration

Pin#	Pin Name	I/O	Function
1	SW3_A	I/O	Analog switch terminal 3 (AFE side)
2	SW4_A	I/O	Analog switch terminal 4 (AFE side)
3	SW5_A	I/O	Analog switch terminal 5 (AFE side)
4	SW6_A	I/O	Analog switch terminal 6 (AFE side)
5	SW7_A	I/O	Analog switch terminal 7 (AFE side)
6	SW8_A	I/O	Analog switch terminal 8 (AFE side)
7	NC	-	No connection (Not internally connected)
8	SW9_A	I/O	Analog switch terminal 9 (AFE side)
9	SW10_A	I/O	Analog switch terminal 10 (AFE side)
10	SW11_A	I/O	Analog switch terminal 11 (AFE side)
11	SW12_A	I/O	Analog switch terminal 12 (AFE side)
12	SW13_A	I/O	Analog switch terminal 13 (AFE side)
13	SW14_A	I/O	Analog switch terminal 14 (AFE side)
14	SW15_A	I/O	Analog switch terminal 15 (AFE side)
15	SW16_A	I/O	Analog switch terminal 16 (AFE side)
16	NC	-	No connection (Not internally connected)
17	DIN4	I	Data input 4 for SW13 to SW16, Hi=ON, Low=OFF
18	VDD	-	Positive low voltage power supply (+5V)
19	VLL	-	Positive voltage supply of low voltage interface (+1.8V~+5V)
20	DIN3	I	Data input 3 for SW9 to SW12, Hi=ON, Low=OFF
21	GND	-	Drive power ground (0V)
22	NC	-	No connection (Not internally connected)
23	DS_ASW	I	GND clamp control, Hi=always disabled, Low=main switches and GND clamp switches are alternately turned on and off
24	NC	-	No connection (Not internally connected)
25	SW16_P	I/O	Analog switch terminal 16 (Probe side)
26	SW15_P	I/O	Analog switch terminal 15 (Probe side)

Table 6 Pin Configuration (cont.)

Pin#	Pin Name	I/O	Function
27	SW14_P	I/O	Analog switch terminal 14 (Probe side)
28	SW13_P	I/O	Analog switch terminal 13 (Probe side)
29	SW12_P	I/O	Analog switch terminal 12 (Probe side)
30	SW11_P	I/O	Analog switch terminal 11 (Probe side)
31	SW10_P	I/O	Analog switch terminal 10 (Probe side)
32	SW9_P	I/O	Analog switch terminal 9 (Probe side)
33	NC	-	No connection (Not internally connected)
34	SW8_P	I/O	Analog switch terminal 8 (Probe side)
35	SW7_P	I/O	Analog switch terminal 7 (Probe side)
36	SW6_P	I/O	Analog switch terminal 6 (Probe side)
37	SW5_P	I/O	Analog switch terminal 5 (Probe side)
38	SW4_P	I/O	Analog switch terminal 4 (Probe side)
39	SW3_P	I/O	Analog switch terminal 3 (Probe side)
40	SW2_P	I/O	Analog switch terminal 2 (Probe side)
41	SW1_P	I/O	Analog switch terminal 1 (Probe side)
42	NC	-	No connection (Not internally connected)
43	LE	I	Latch enable input, Hi=Hold data, Low=Latch data input
44	NC	-	No connection (Not internally connected)
45	GND	-	Drive power ground (0V)
46	DIN1	I	Data input 1 for SW1 to SW4, Hi=ON, Low=OFF
47	VLL	-	Positive voltage supply of low voltage interface (+1.8V~+5V)
48	VDD	-	Positive low voltage power supply (+5V)
49	DIN2	I	Data input 2 for SW5 to SW8, Hi=ON, Low=OFF
50	NC	-	No connection (Not internally connected)
51	SW1_A	I/O	Analog switch terminal 1 (AFE side)
52	SW2_A	I/O	Analog switch terminal 2 (AFE side)

■ Package

Table 7 Package Drawing Codes

Package Name	Dimension	Tray	Marking	Land	Packing
QFN-52(0808)B	QN052-B-P-SD	QFN8x8-B-T-SD	QN052-B-M-S3	QN052-B-L-SD	QN052-B-K-SD

■ Storage, Mounting

1. Storage conditions

- **1.1** The storage location should be kept at 5 to 35°C and 40 to 70% relative humidity. Keeping in a dry box is recommended. Moisture-proof property is assured for 12 months from delivery date for sealed moisture-proof packing, while it is guaranteed for 7 days from unpacked date under the condition above.
- 1.2 When the storage conditions do not conform to those above or other conditions occur indicating moisture exposure, the ICs should be dried to avoid package cracks. A baking process at 125°C lasting for 24 hours results in sufficient dehumidification. The baking is not allowed more than twice, and the ICs should be mounted within 7 days after initial baking or within 10 days of total exposure after the second dehumidification.

2. Reflow soldering

The temperature rise may be different in the resin and a terminal part due to the reflow soldering. It is necessary to check the package surface temperature (resin) before setting the temperature profile. **Figure 6** shows the resistance to soldering heat condition for package (Reflow method). Confirm the heat resistance of the package shown below. (Based on JEDEC J-STD-020).

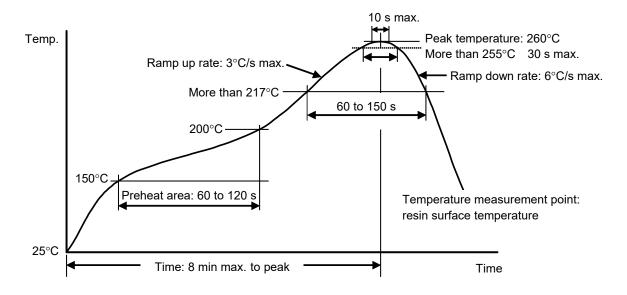


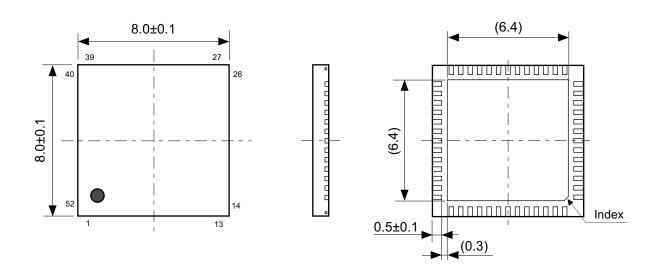
Figure 6 Resistance to Soldering Heat Condition for Package (Reflow Method)

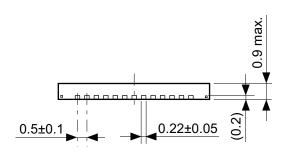
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■ Cautions

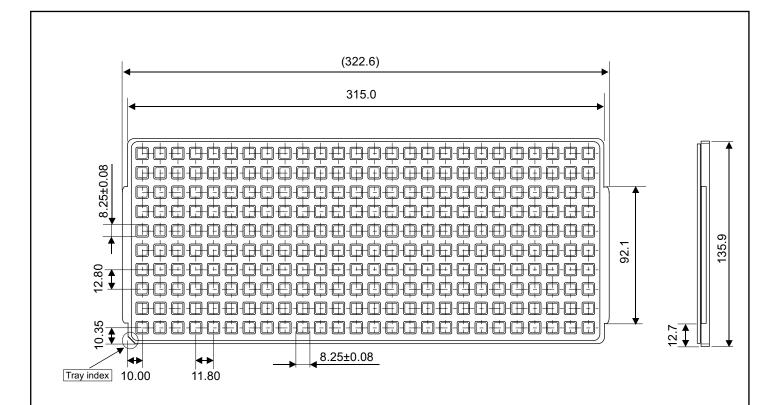
- 1. Customers are advised to follow the cautions below to protect products from damage caused by electrical static discharge (ESD).
 - 1. 1 Material of container or any device to carry products should be free from ESD, which may be caused by vibration while transportation. It is recommended that electric-conductive container or aluminum sheet be used as an effective countermeasure.
 - **1.2** Those that touch products, such as work platform, machine, or measurement/test equipment, should be grounded.
 - 1.3 Those who deal with products should be grounded through a large series impedance around $100k\Omega$ to $1M\Omega$.
 - **1.4** Prevent friction with other materials made with high polymer.
 - 1. 5 Prevent vibration or friction when carrying the printed circuit board (PCB) where products are mounted. To short circuit terminals is a recommended countermeasure to keep the same electric potential on the PCB.
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- 4. Products may experience failures or malfunction in poor surroundings, such as electrical leakage in products due to long-term use in high humidity, malfunctioning or permanent damage due to chemical reaction of products in corrosive environment or due to discharge by strongly charged object near products or due to excessive mechanical shock. To use products in radiation environment is not assumed. To use products near material easy to ignite may cause a fire due to its flammable package. Avoid using products in such environment or take appropriate countermeasures depending on the environment.
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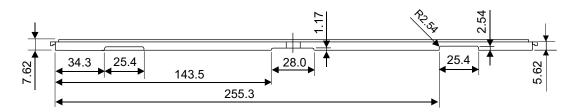


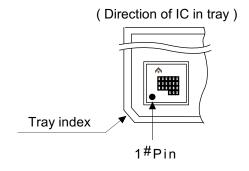


No. QN052-B-P-SD-1.0

TITLE	QFN52-B-PKG Dimensions					
No.	QN052-B-P-SD-1.0					
ANGLE	♦ €∃					
UNIT	mm					
	ABLIC Inc.					

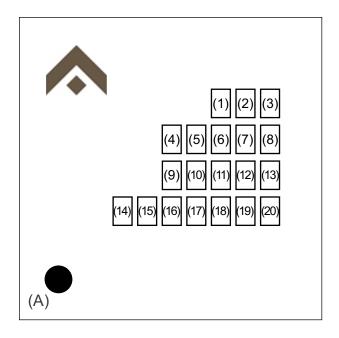






No. QFN8x8-B-T-SD-1.0

TITLE	QFN8x8-B-Tray					
No.	QFN8:	QFN8x8-B-T-SD-1.0				
ANGLE		QTY.	260			
UNIT	mm					
ABLIC Inc.						



(1) : Year of assembly

(2) : Month of assembly

(3) : Week of assembly

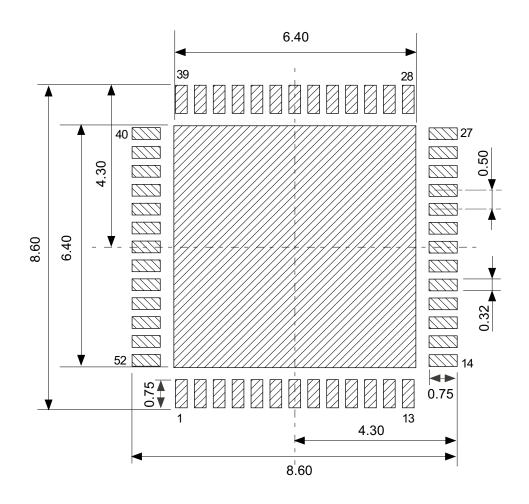
(4) to (13) : Product code

(14) to (20): Quality control code

(A) : 1-pin mark

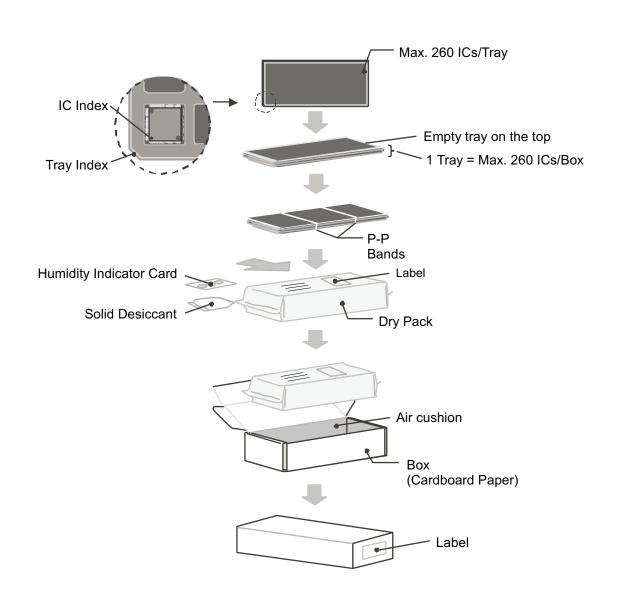
No. QN052-B-M-S3-1.0

TITLE	QFN52-B-Markings (S-UM6502B)			
No.	QN052-B-M-S3-1.0			
ANGLE				
UNIT	TYPE	LASER		
ABLIC Inc.				



No. QN052-B-L-SD-1.0

TITLE	QFN52-B -Land Recommendation			
No. QN052-B-L-SD-1.0				
ANGLE				
UNIT	mm			
ABLIC Inc.				



No. QN052-B-K-SD-1.0

TITLE	QFN52-B -Packing Procedure
No.	QN052-B-K-SD-1.0
ANGLE	
UNIT	
ABLIC Inc.	

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